



Connectors > Socket Connectors > IC Sockets > LGA Sockets > LGA 2011 Sockets



IC Socket Type: **LGA 2011**

Connector System: **Board-to-Board**

Number of Positions: **2011**

Contact Mating Area Plating Material Thickness: **[15 µin]**

Centerline (Pitch): **1.02 mm [.04 in]**

[All LGA 2011 Sockets \(0\)](#)

Features

Product Type Features

Connector System	Board-to-Board
Connector & Contact Terminates To	Printed Circuit Board

Configuration Features

Number of Positions	2011
Grid Spacing	1.016 x .8814 mm[.040 x .0347 in]

Body Features

Frame Style	Square
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Contact Features

Contact Mating Area Plating Material	Gold
Contact Base Material	Copper Alloy
IC Socket Type	LGA 2011
	15 µin
Contact Current Rating (Max)	.5 A



Mechanical Attachment

PCB Mounting Style	Surface Mount Solder Ball
Connector Mounting Type	Board Mount

Housing Features

Housing Material	High Temperature Thermoplastic
Housing Color	Black
Centerline (Pitch)	1.02 mm[.04 in]

Usage Conditions

Operating Temperature Range	-25 – 100 °C[-13 – 212 °F]
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Operation/Application

Circuit Application	Signal
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Industry Standards

UL Flammability Rating	UL 94V-0
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Packaging Features

Tray Color	Black
Packaging Method	Tray

Other

Socket Connector Comment	Lead-Free Solderball
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Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JAN 2022 (223) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C

Product Compliance Disclaimer



This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

Compatible Parts

TE Part # CAT-L59017-A68H
LGA 2011 Hardware: ILM Assembly

TE Part # 1-1554653-1
SOCKET ASSY LGA2011, 0.76Au

TE Part # 2134440-3
BP ASSY, LGA2011,9MM STUD

TE Part # 1-2229348-1
ILM DUST COVER LGA2011-3

TE Part # 2134440-5
BP ASSY WITH 8.5MM STUD, LGA2011

Documents

Product Drawings
SOCKET ASSY LGA2011-3
English

CAD Files
3D PDF
3D
Customer View Model
ENG_CVM_CVM_2201838-1_C.2d_dxf.zip
English
Customer View Model
ENG_CVM_CVM_2201838-1_C.3d_igs.zip
English
Customer View Model
ENG_CVM_CVM_2201838-1_C.3d_stp.zip



English

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Product Specifications

Application Specification

English